



Vincotech

10-FE12APA015SH01-PB18E08Z

datasheet

flow3xANPFC 1

1200 V / 15 A

Features

- 3xAdvanced Neutral Boost PFC
- Integrated DC capacitor
- Kelvin Emitter for improved switching performance
- Integrated sixpack with open emitter
- Built-in NTC

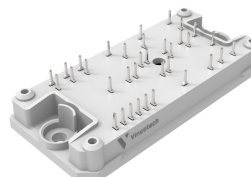
Target applications

- Embedded Drives
- Heat Pumps
- HVAC
- Industrial Drives

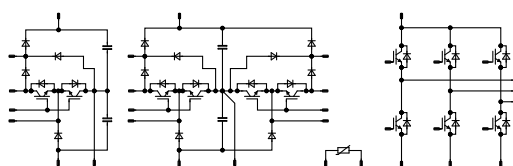
Types

- 10-FE12APA015SH01-PB18E08Z

flow 1 12 mm housing



Schematic





Vincotech

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		1200	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	22	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	45	A
Turn off safe operating area		$T_j = 150\text{ °C}$, $V_{CE} = 1200\text{ V}$	60	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	68	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$, $V_{CC} = 800\text{ V}$ $T_j = 150\text{ °C}$	10	μs
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

Negative Neutral Point Switch

Collector-emitter voltage	V_{CES}		650	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	32	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	90	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	68	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

Inverter Diode

Peak repetitive reverse voltage	V_{RRM}		1200	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	16	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 25\text{ °C}$	65	A
Surge current capability	I_{Pt}		21	A^2s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	43	W
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$



Vincotech

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Positive Neutral Point Switch				
Collector-emitter voltage	V_{CES}		650	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	32	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	90	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	68	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		175	°C

Negative Neutral Point Diode

Peak repetitive reverse voltage	V_{RRM}		1600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	35	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	200	A
Surge current capability	I^2t		200	A ² s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	44	W
Maximum junction temperature	T_{jmax}		150	°C

Positive Neutral Point Diode

Peak repetitive reverse voltage	V_{RRM}		1600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	35	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	200	A
Surge current capability	I^2t		200	A ² s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	44	W
Maximum junction temperature	T_{jmax}		150	°C



Vincotech

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Positive Boost Diode				
Peak repetitive reverse voltage	V_{RRM}		650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	18	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	66	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 25\text{ °C}$	162	A
Surge current capability	I^2t		131	A ² s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	40	W
Maximum junction temperature	T_{jmax}		175	°C

Positive Boost Blocking Diode

Peak repetitive reverse voltage	V_{RRM}		1600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	35	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	200	A
Surge current capability	I^2t		200	A ² s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	44	W
Maximum junction temperature	T_{jmax}		150	°C

Positive Boost Diode Protection Diode

Peak repetitive reverse voltage	V_{RRM}		650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	16	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	12	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	38	W
Maximum junction temperature	T_{jmax}		175	°C



Vincotech

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Negative Boost Diode				
Peak repetitive reverse voltage	V_{RRM}		650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	18	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	66	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 25\text{ °C}$	162	A
Surge current capability	I_{t}		131	A ² s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	40	W
Maximum junction temperature	T_{jmax}		175	°C

Capacitor (PFC)

Maximum DC voltage	V_{MAX}		630	V
Operation Temperature	T_{op}		-55 ... 150	°C

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
Isolation voltage	V_{isol}	AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			>12,7	mm
Clearance			8.67	mm
Comparative Tracking Index	CTI		≥ 600	

*100 % tested in production



Vincotech

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]		Min	Typ	Max	

Inverter Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0005	25	5,3	5,8	6,3	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		15	25 150	1,78	1,91 2,29	2,42 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	1200		25			2	µA
Gate-emitter leakage current	I_{GES}		20	0		25			120	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}	$f = 1 \text{ Mhz}$	0	25	25			875		pF
Output capacitance	C_{oes}							75		pF
Reverse transfer capacitance	C_{res}							45		pF
Gate charge	Q_g	$V_{CC} = 960 \text{ V}$	15		15	25		75		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,39		K/W
--	---------------	---	--	--	--	--	--	------	--	-----

Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 16 \text{ Ω}$ $R_{goff} = 16 \text{ Ω}$	±15	600	15	25 125 150		51,49 51,17 51,35		ns
Rise time	t_r					25 125 150		23,33 24,69 24,94		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		142,18 193,22 205,43		ns
Fall time	t_f					25 125 150		56,92 95,01 106,08		ns
Turn-on energy (per pulse)	E_{on}	$Q_{fwd}=0,677 \text{ µC}$ $Q_{fwd}=1,51 \text{ µC}$ $Q_{fwd}=1,84 \text{ µC}$				25 125 150		0,741 1,08 1,2		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		0,615 1,01 1,12		mWs



Vincotech

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Negative Neutral Point Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0003	25	3,3	4	4,7	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		30	25 125 150		1,7 1,93 2	2,22 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	650		25			40	µA
Gate-emitter leakage current	I_{GES}		20	0		25			120	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}	$f = 1 \text{ Mhz}$	0	25		25		1800		pF
Output capacitance	C_{oes}							45		pF
Reverse transfer capacitance	C_{res}							9		pF
Gate charge	Q_g	$V_{CC} = 520 \text{ V}$	15		30	25		65		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,39		K/W
--	---------------	---	--	--	--	--	--	------	--	-----

Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 16 \text{ } \Omega$ $R_{goff} = 16 \text{ } \Omega$	± 15	350	16	25 125 150		130,15 129,32 129,05		ns
Rise time	t_r					25 125 150		32 32,05 31,88		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		101,63 121,36 126,1		ns
Fall time	t_f					25 125 150		1,47 2,37 2,59		ns
Turn-on energy (per pulse)	E_{on}					25 125 150		0,196 0,208 0,206		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		0,086 0,145 0,16		mWs



Vincotech

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Inverter Diode

Static

Forward voltage	V_F				15	25 150		2,6 2,65	2,71 ⁽¹⁾ 2,77 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1200$ V				25 150			60 1800	μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						2,2		K/W
--	---------------	---------------------------------------	--	--	--	--	--	-----	--	-----

Dynamic

Peak recovery current	I_{RRM}	$di/dt=589$ A/μs $di/dt=568$ A/μs $di/dt=588$ A/μs	± 15	600	15	25 125 150		11,25 13,58 14,49		A
Reverse recovery time	t_{rr}					25 125 150		166,79 367,13 420,17		ns
Recovered charge	Q_r					25 125 150		0,677 1,51 1,84		μC
Reverse recovered energy	E_{rec}					25 125 150		0,218 0,597 0,724		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		186,15 145,21 134,05		A/μs



Vincotech

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Positive Neutral Point Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0003	25	3,3	4	4,7	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		30	25 125 150		1,7 1,93 2	2,22 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	650		25			40	µA
Gate-emitter leakage current	I_{GES}		20	0		25			120	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}	$f = 1 \text{ Mhz}$	0	25		25		1800		pF
Output capacitance	C_{oes}							45		pF
Reverse transfer capacitance	C_{res}							9		pF
Gate charge	Q_g	$V_{CC} = 520 \text{ V}$	15		30	25		65		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,39		K/W
--	---------------	---	--	--	--	--	--	------	--	-----

Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 16 \text{ } \Omega$ $R_{goff} = 16 \text{ } \Omega$	± 15	350	16	25 125 150		130,15 129,32 129,05		ns
Rise time	t_r					25 125 150		32 32,05 31,88		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		101,63 121,36 126,1		ns
Fall time	t_f					25 125 150		1,47 2,37 2,59		ns
Turn-on energy (per pulse)	E_{on}					25 125 150		0,196 0,208 0,206		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		0,086 0,145 0,16		mWs



Vincotech

Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]		Min	Typ	Max	

Negative Neutral Point Diode

Static

Forward voltage	V_F				5	25 125 150		0,928 0,813 0,784	1,1 ⁽¹⁾		V
Reverse leakage current	I_R	$V_i = 1600$ V				25 150				100 1000	μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,6			K/W
--	---------------	------------------------------------	--	--	--	--	--	-----	--	--	-----

Positive Neutral Point Diode

Static

Forward voltage	V_F				5	25 125 150		0,928 0,813 0,784	1,1 ⁽¹⁾		V
Reverse leakage current	I_R	$V_i = 1600$ V				25 150				100 1000	μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,6			K/W
--	---------------	------------------------------------	--	--	--	--	--	-----	--	--	-----



Vincotech

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Positive Boost Diode

Static

Forward voltage	V_F				16	25 125 150		1,55 1,89 2	1,8 ⁽¹⁾	V
Reverse leakage current	I_R	$V_i = 650$ V				25		18	95	μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						2,38		K/W
--	---------------	---------------------------------------	--	--	--	--	--	------	--	-----

Dynamic

Peak recovery current	I_{RRM}	$di/dt=746$ A/μs $di/dt=734$ A/μs $di/dt=757$ A/μs	± 15	350	16	25 125 150		4,16 3,84 3,85		A
Reverse recovery time	t_{rr}					25 125 150		18,07 19,68 20,15		ns
Recovered charge	Q_r					25 125 150		0,04 0,039 0,04		μC
Reverse recovered energy	E_{rec}					25 125 150		$3,772 \times 10^{-3}$ $3,75 \times 10^{-3}$ $3,974 \times 10^{-3}$		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		622,41 544,86 437,94		A/μs



Vincotech

Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]		Min	Typ	Max	

Positive Boost Blocking Diode

Static

Forward voltage	V_F				5	25 125 150		0,928 0,813 0,784	1,1 ⁽¹⁾		V
Reverse leakage current	I_R	$V_r = 1600$ V				25 150			100 1000		μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,6			K/W
--	---------------	---------------------------------------	--	--	--	--	--	-----	--	--	-----

Positive Boost Diode Protection Diode

Static

Forward voltage	V_F				6	25 125 150	1,23	1,72 1,58 1,54	1,87 ⁽¹⁾		V
Reverse leakage current	I_R	$V_r = 650$ V				25			0,1		μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						2,53			K/W
--	---------------	---------------------------------------	--	--	--	--	--	------	--	--	-----



Vincotech

10-FE12APA015SH01-PB18E08Z
datasheet

Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]		Min	Typ	Max	

Negative Boost Diode

Static

Forward voltage	V_F				16	25 125 150		1,55 1,89 2	1,8 ⁽¹⁾		V
Reverse leakage current	I_R	$V_i = 650$ V				25		18	95		μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						2,38			K/W
--	---------------	---------------------------------------	--	--	--	--	--	------	--	--	-----

Dynamic

Peak recovery current	I_{RRM}	$di/dt=746$ A/μs $di/dt=734$ A/μs $di/dt=757$ A/μs	± 15	350	16	25 125 150		4,16 3,84 3,85			A
Reverse recovery time	t_{rr}					25 125 150		18,07 19,68 20,15			ns
Recovered charge	Q_r					25 125 150		0,04 0,039 0,04			μC
Reverse recovered energy	E_{rec}					25 125 150		$3,772 \times 10^{-3}$ $3,75 \times 10^{-3}$ $3,974 \times 10^{-3}$			mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		622,41 544,86 437,94			A/μs



Vincotech

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Capacitor (PFC)

Static

Capacitance	C	DC bias voltage = 0 V				25		33		nF
Tolerance							-5		5	%

Thermistor

Static

Rated resistance	R					25		22		kΩ
Deviation of R_{100}	$\Delta_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	P							5		mW
Power dissipation constant	d					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ± 1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ± 1 %						4000		K
Vincotech Thermistor Reference									I	

⁽¹⁾ Value at chip level

⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.



Vincotech

10-FE12APA015SH01-PB18E08Z

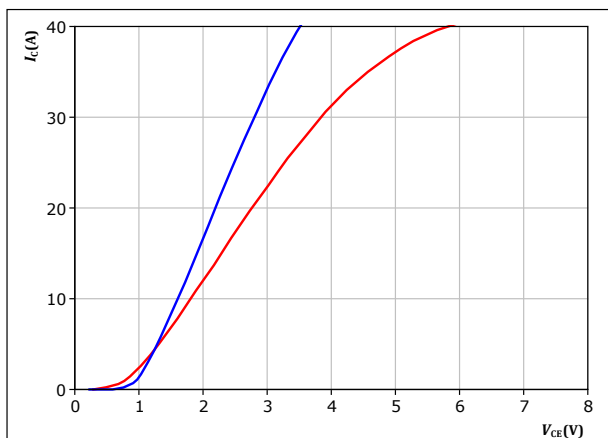
datasheet

Inverter Switch Characteristics

figure 1. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

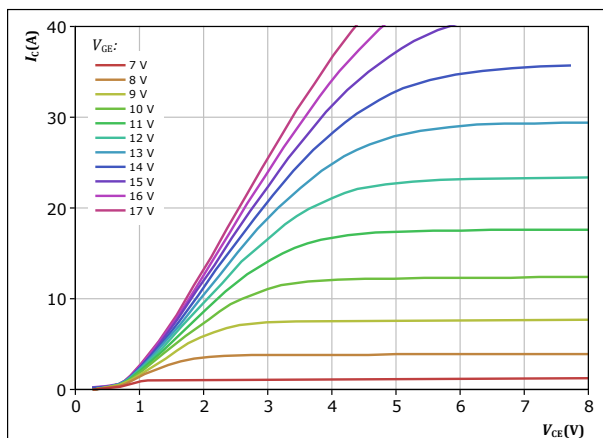


$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_J: 25 ^\circ C$
 $150 ^\circ C$

figure 2. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

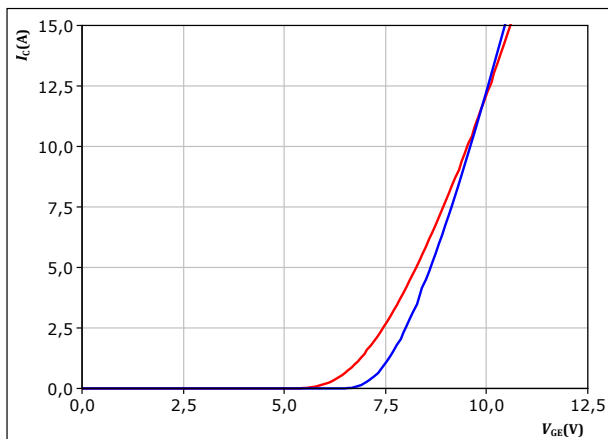


$t_p = 250 \mu s$
 $T_J = 150 ^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

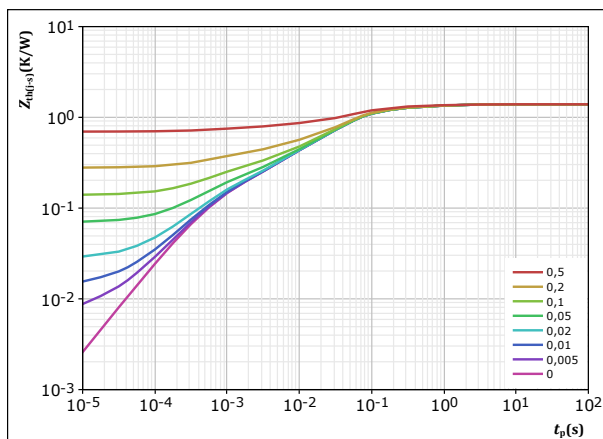


$t_p = 250 \mu s$
 $V_{CE} = 10 V$
 $T_J: 25 ^\circ C$
 $150 ^\circ C$

figure 4. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,392 K/W$
IGBT thermal model values

$R (K/W)$	$\tau (s)$
9,77E-02	1,22E+00
1,79E-01	2,08E-01
8,34E-01	4,54E-02
1,64E-01	4,89E-03
1,17E-01	5,62E-04



Vincotech

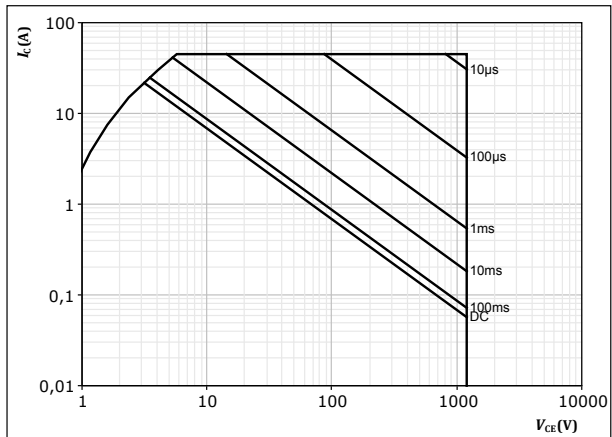
10-FE12APA015SH01-PB18E08Z
datasheet

Inverter Switch Characteristics

figure 5. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



$D =$ single pulse

$T_s = 80$ °C

$V_{GE} = 15$ V

$T_j = T_{jmax}$



Vincotech

10-FE12APA015SH01-PB18E08Z

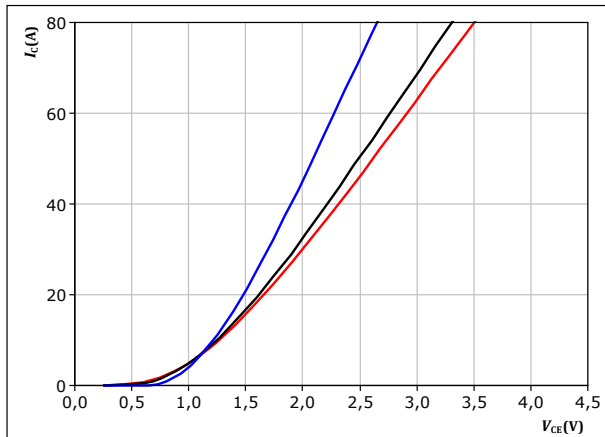
datasheet

Negative Neutral Point Switch Characteristics

figure 6. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

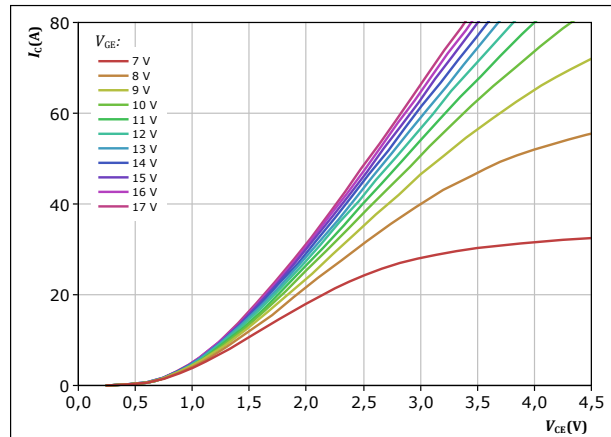


$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_j: 25 \text{ } ^\circ C$
 $125 \text{ } ^\circ C$
 $150 \text{ } ^\circ C$

figure 7. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

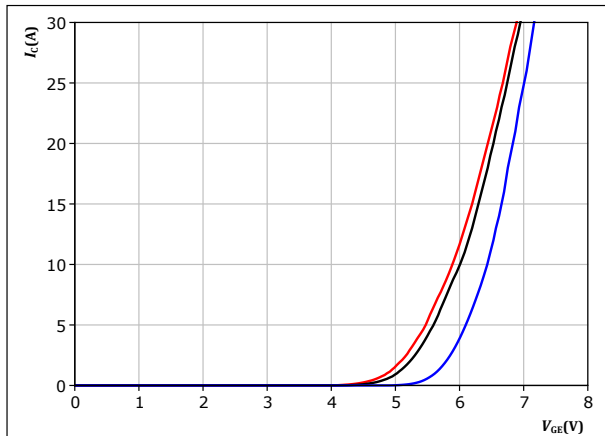


$t_p = 250 \mu s$
 $T_j = 150 \text{ } ^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 8. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

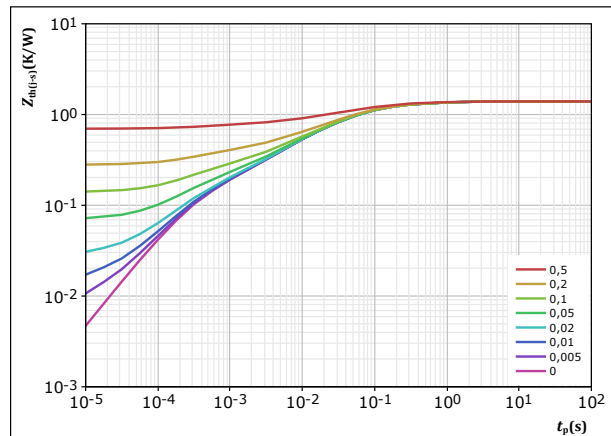


$t_p = 250 \mu s$
 $V_{CE} = 10 V$
 $T_j: 25 \text{ } ^\circ C$
 $125 \text{ } ^\circ C$
 $150 \text{ } ^\circ C$

figure 9. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,394 K/W$
IGBT thermal model values

R (K/W)	τ (s)
8,66E-02	1,03E+00
1,95E-01	1,93E-01
5,59E-01	5,17E-02
3,47E-01	9,99E-03
9,37E-02	1,86E-03
1,12E-01	2,95E-04



Vincotech

10-FE12APA015SH01-PB18E08Z
datasheet

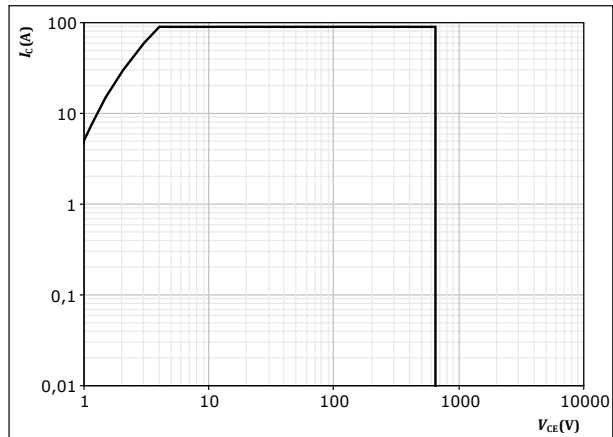
Negative Neutral Point Switch Characteristics

figure 10.

IGBT

Safe operating area

$$I_C = f(V_{CE})$$



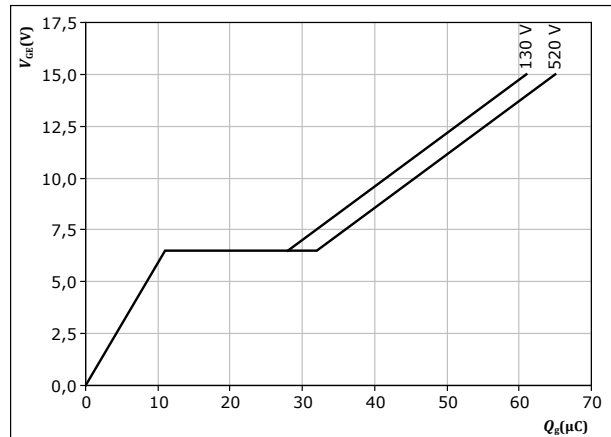
$D =$ single pulse
 $T_s = 80$ °C
 $V_{GE} = 15$ V
 $T_j = T_{jmax}$

figure 11.

IGBT

Gate voltage vs gate charge

$$V_{GE} = f(Q_g)$$



$I_C = 30$ A
 $T_j = 25$ °C



Vincotech

10-FE12APA015SH01-PB18E08Z
datasheet

Inverter Diode Characteristics

figure 12.

FWD

Typical forward characteristics

$$I_F = f(V_F)$$

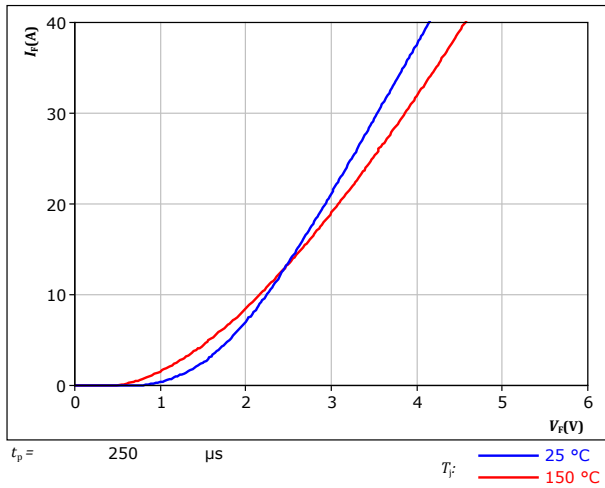
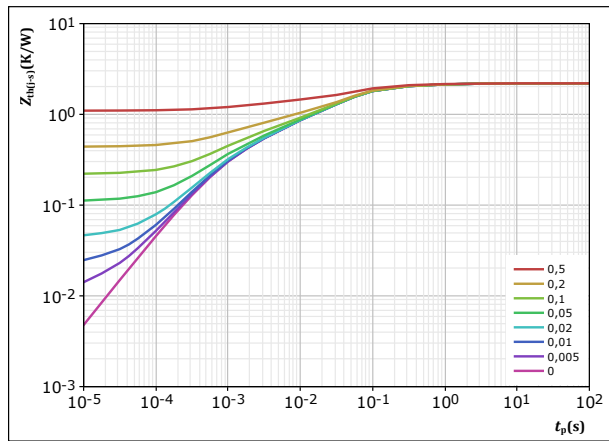


figure 13.

FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	t_p / T	
$R_{th(j-s)} =$	2,196	K/W
FWD thermal model values		
R (K/W)	τ (s)	
1,03E-01	1,73E+00	
3,30E-01	1,92E-01	
1,14E+00	4,08E-02	
3,82E-01	3,95E-03	
2,46E-01	6,95E-04	



Vincotech

10-FE12APA015SH01-PB18E08Z

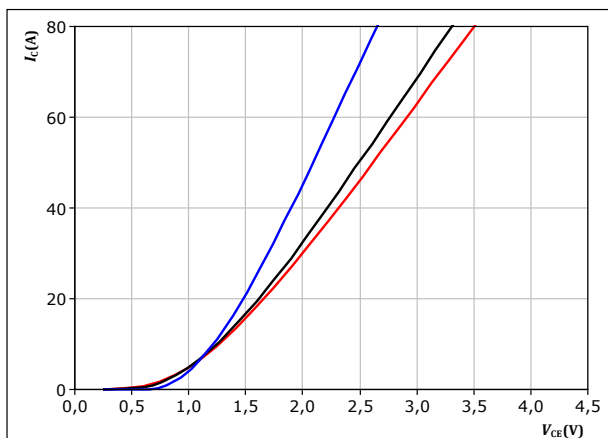
datasheet

Positive Neutral Point Switch Characteristics

figure 14. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

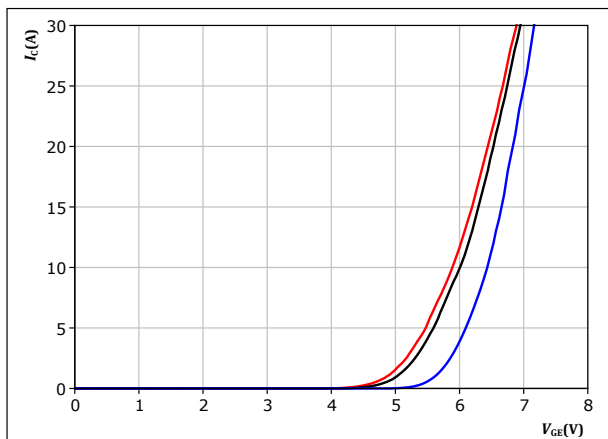


$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_j: 25 \text{ } ^\circ C$
 $125 \text{ } ^\circ C$
 $150 \text{ } ^\circ C$

figure 16. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

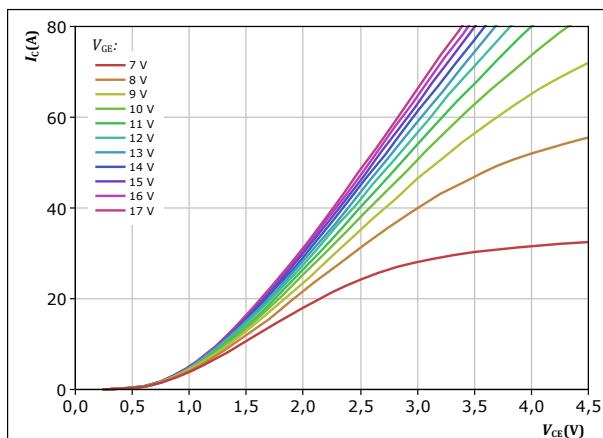


$t_p = 250 \mu s$
 $V_{CE} = 10 V$
 $T_j: 25 \text{ } ^\circ C$
 $125 \text{ } ^\circ C$
 $150 \text{ } ^\circ C$

figure 15. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

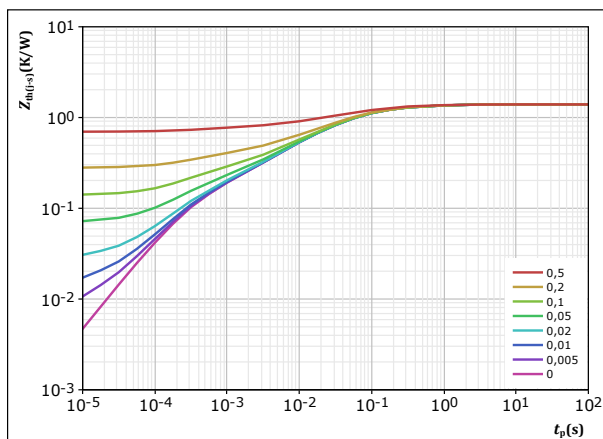


$t_p = 250 \mu s$
 $T_j = 150 \text{ } ^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 17. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,394 \text{ K/W}$
 IGBT thermal model values

$R \text{ (K/W)}$	$\tau \text{ (s)}$
8,66E-02	1,03E+00
1,95E-01	1,93E-01
5,59E-01	5,17E-02
3,47E-01	9,99E-03
9,37E-02	1,86E-03
1,12E-01	2,95E-04



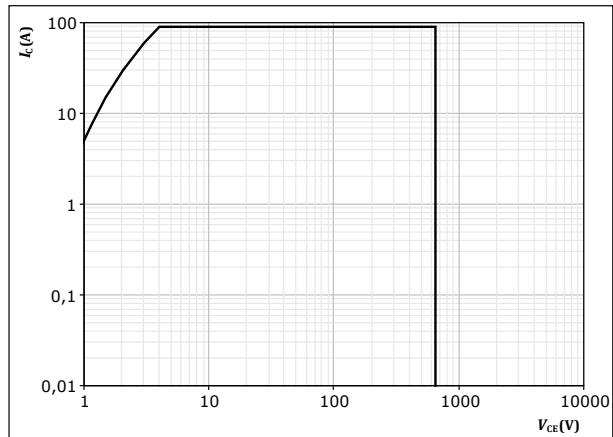
Vincotech

Positive Neutral Point Switch Characteristics

figure 18. IGBT

Safe operating area

$$I_C = f(V_{CE})$$

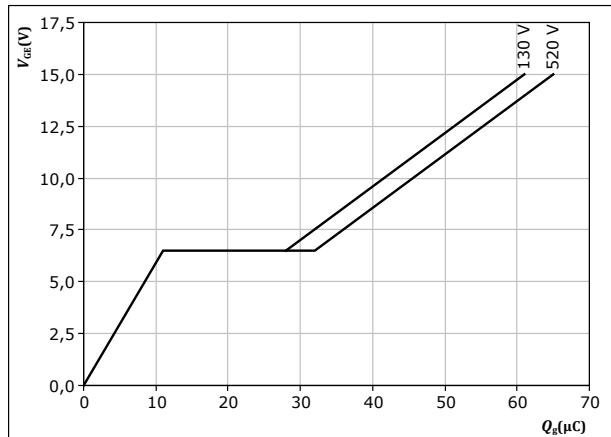


$D =$ single pulse
 $T_s = 80$ °C
 $V_{GE} = 15$ V
 $T_j = T_{jmax}$

figure 19. IGBT

Gate voltage vs gate charge

$$V_{GE} = f(Q_g)$$



$I_C = 30$ A
 $T_j = 25$ °C



Vincotech

10-FE12APA015SH01-PB18E08Z
datasheet

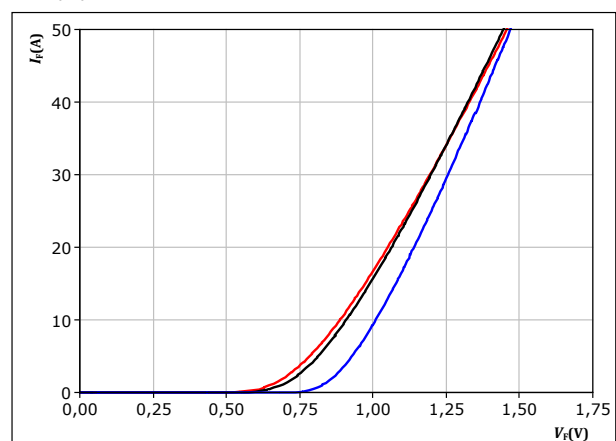
Negative Neutral Point Diode Characteristics

figure 20.

Rectifier

Typical forward characteristics

$$I_F = f(V_F)$$



$t_p = 250 \mu s$

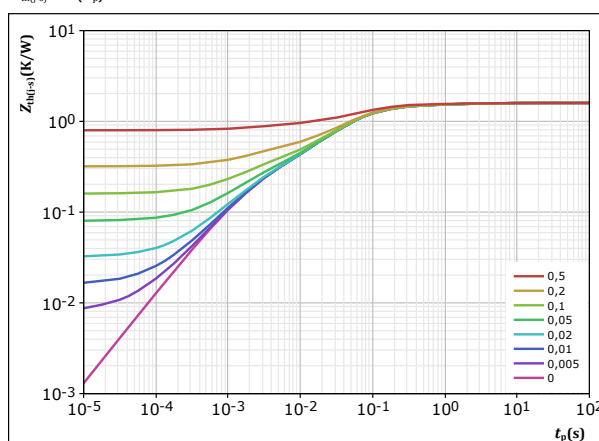
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 21.

Rectifier

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	t_p / T	
$R_{th(j-s)} =$	1,595	K/W
Rectifier thermal model values		
R (K/W)	τ (s)	
5,74E-02	3,35E+00	
1,49E-01	4,41E-01	
9,92E-01	6,12E-02	
2,25E-01	1,48E-02	
1,72E-01	1,74E-03	



Vincotech

10-FE12APA015SH01-PB18E08Z
datasheet

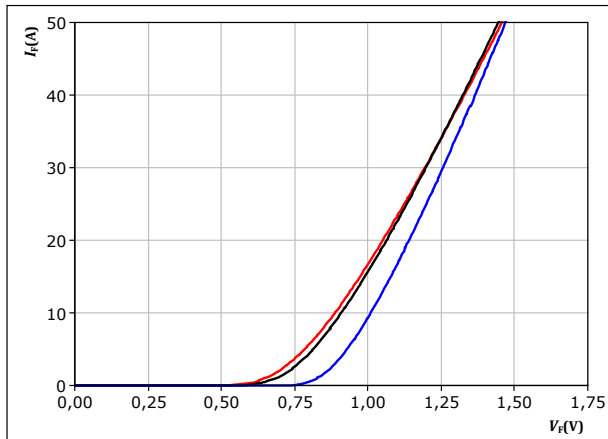
Positive Neutral Point Diode Characteristics

figure 22.

Rectifier

Typical forward characteristics

$$I_F = f(V_F)$$



$t_p = 250 \mu s$

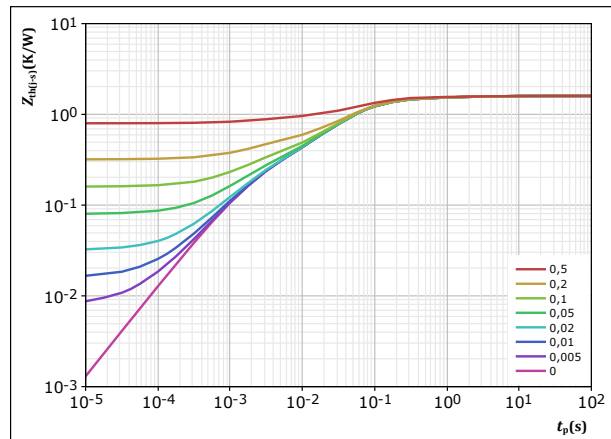
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 23.

Rectifier

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	t_p / T
$R_{th(j-s)} =$	1,595 K/W
Rectifier thermal model values	
R (K/W)	τ (s)
5,74E-02	3,35E+00
1,49E-01	4,41E-01
9,92E-01	6,12E-02
2,25E-01	1,48E-02
1,72E-01	1,74E-03



Vincotech

10-FE12APA015SH01-PB18E08Z
datasheet

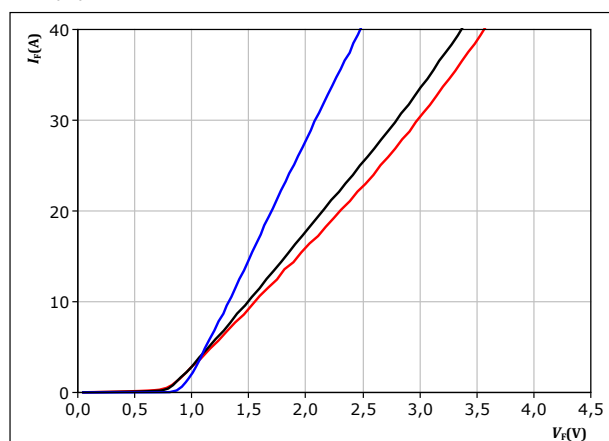
Positive Boost Diode Characteristics

figure 24.

FWD

Typical forward characteristics

$$I_F = f(V_F)$$



$t_p = 250 \mu s$

T_j :

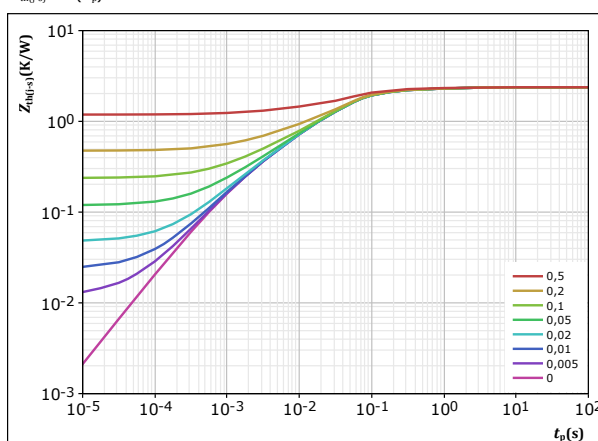
- 25 °C
- 125 °C
- 150 °C

figure 25.

FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$

$R_{th(j-s)} = 2,375 \text{ K/W}$

FWD thermal model values

$R \text{ (K/W)}$	$\tau \text{ (s)}$
1,22E-01	1,87E+00
3,54E-01	1,79E-01
1,50E+00	4,00E-02
3,30E-01	4,36E-03
7,38E-02	7,61E-04



Vincotech

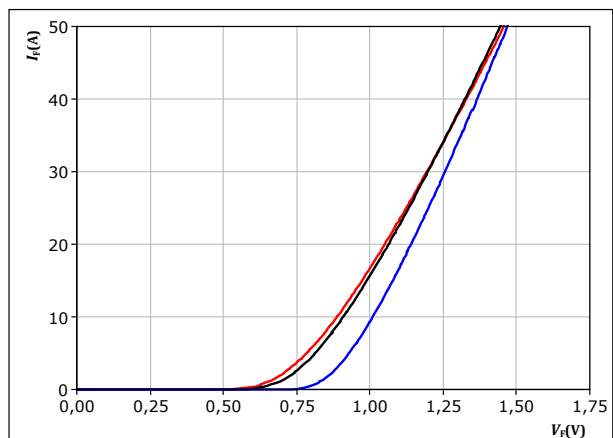
Positive Boost Blocking Diode Characteristics

figure 26.

Rectifier

Typical forward characteristics

$$I_F = f(V_F)$$



$t_p = 250 \mu s$

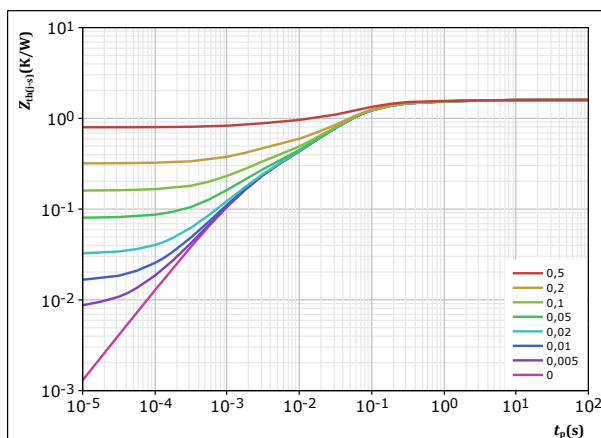
T_J :
— 25 °C
— 125 °C
— 150 °C

figure 27.

Rectifier

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,595 \text{ K/W}$
Rectifier thermal model values

$R \text{ (K/W)}$	$\tau \text{ (s)}$
5,74E-02	3,35E+00
1,49E-01	4,41E-01
9,92E-01	6,12E-02
2,25E-01	1,48E-02
1,72E-01	1,74E-03



Vincotech

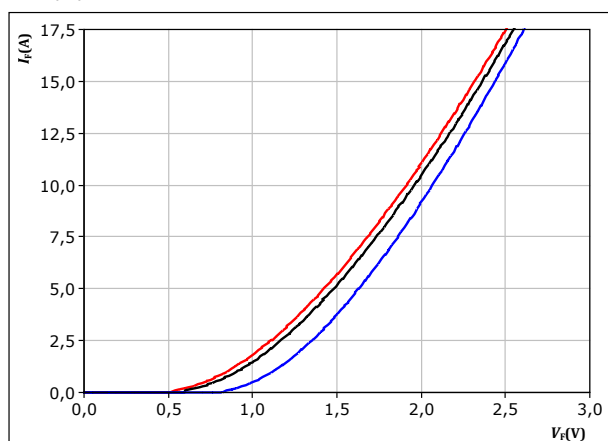
Positive Boost Diode Protection Diode Characteristics

figure 28.

FWD

Typical forward characteristics

$$I_F = f(V_F)$$



$t_p = 250 \mu s$

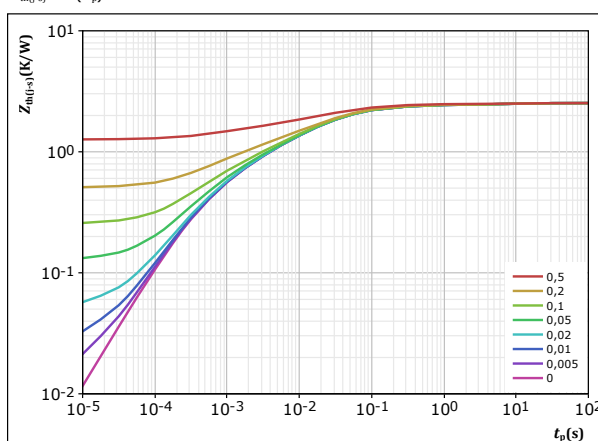
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 29.

FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$

$R_{th(j-s)} = 2,527 \text{ K/W}$

FWD thermal model values

$R \text{ (K/W)}$	$\tau \text{ (s)}$
9,24E-02	9,29E+00
1,75E-01	3,21E-01
7,31E-01	4,97E-02
7,14E-01	1,16E-02
4,89E-01	2,11E-03
3,27E-01	3,78E-04



Vincotech

10-FE12APA015SH01-PB18E08Z
datasheet

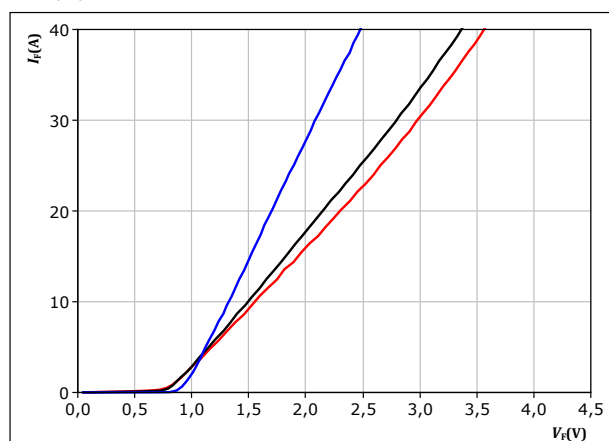
Negative Boost Diode Characteristics

figure 30.

FWD

Typical forward characteristics

$$I_F = f(V_F)$$



$t_p = 250 \mu s$

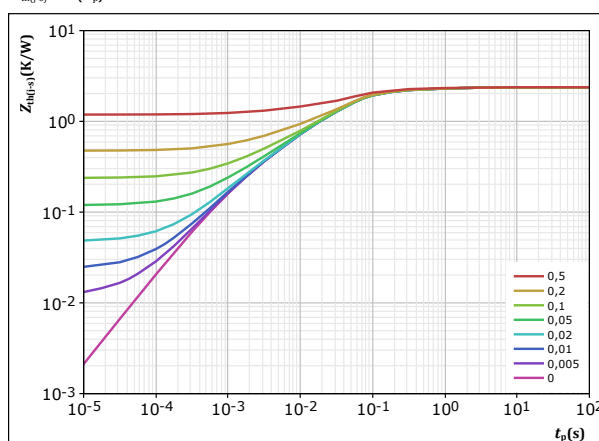
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 31.

FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	t_p / T	
$R_{th(j-s)} =$	2,375	K/W
FWD thermal model values		
R (K/W)	τ (s)	
1,22E-01	1,87E+00	
3,54E-01	1,79E-01	
1,50E+00	4,00E-02	
3,30E-01	4,36E-03	
7,38E-02	7,61E-04	



Vincotech

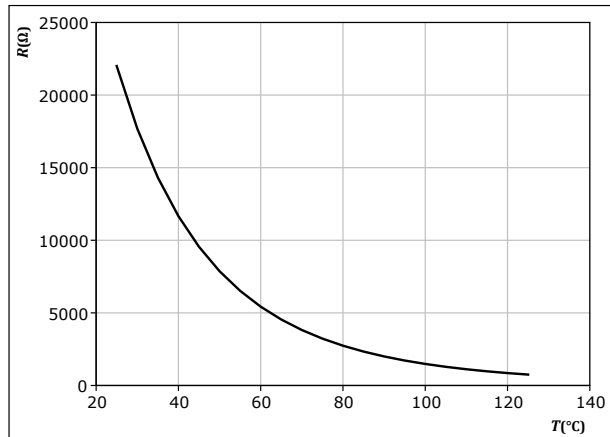
10-FE12APA015SH01-PB18E08Z
datasheet

Thermistor Characteristics

figure 32. Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$





Vincotech

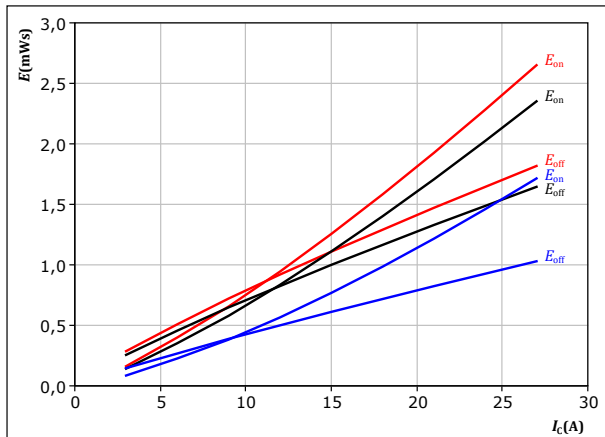
10-FE12APA015SH01-PB18E08Z
datasheet

Inverter Switching Characteristics

figure 33. IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_C)$$



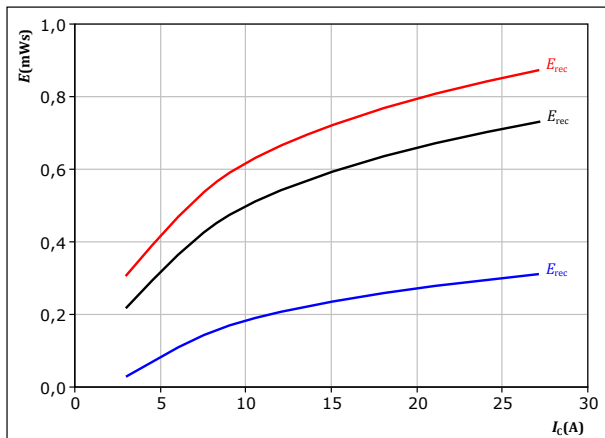
With an inductive load at

$V_{CE} =$	600	V	$T_j:$	25 °C
$V_{GE} =$	±15	V		125 °C
$R_{gon} =$	16	Ω		150 °C
$R_{goff} =$	16	Ω		

figure 35. FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_C)$$



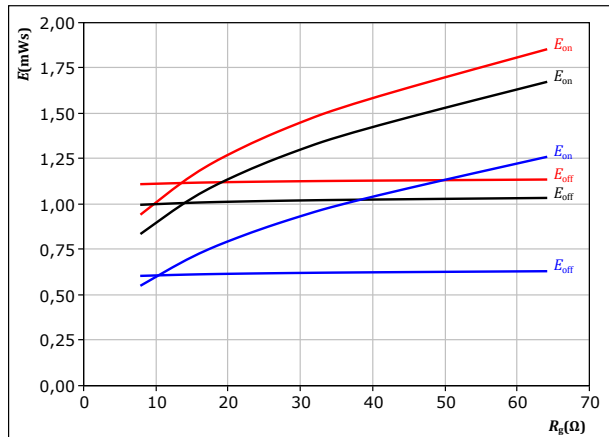
With an inductive load at

$V_{CE} =$	600	V	$T_j:$	25 °C
$V_{GE} =$	±15	V		125 °C
$R_{gon} =$	16	Ω		150 °C

figure 34. IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



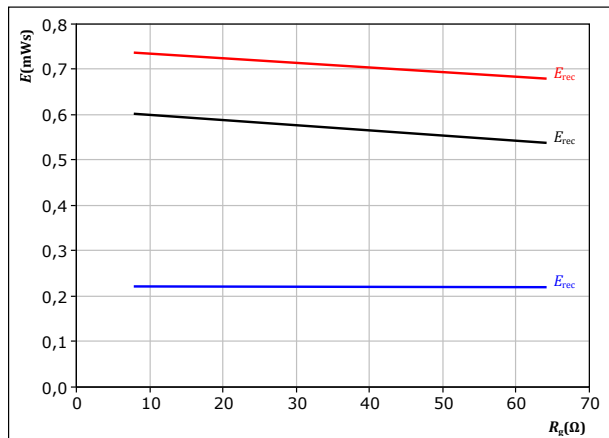
With an inductive load at

$V_{CE} =$	600	V	$T_j:$	25 °C
$V_{GE} =$	±15	V		125 °C
$I_C =$	15	A		150 °C

figure 36. FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} =$	600	V	$T_j:$	25 °C
$V_{GE} =$	±15	V		125 °C
$I_C =$	15	A		150 °C



Vincotech

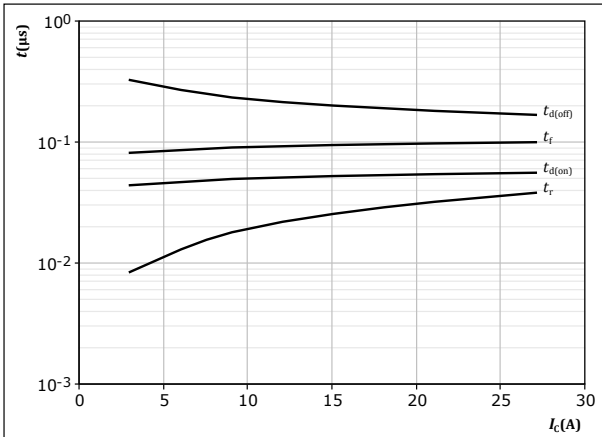
10-FE12APA015SH01-PB18E08Z
datasheet

Inverter Switching Characteristics

figure 37.

IGBT

Typical switching times as a function of collector current
 $t = f(I_C)$



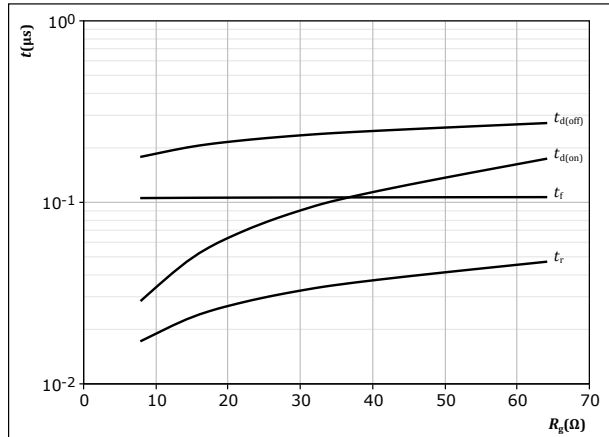
With an inductive load at

$T_j = 150$ °C
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω
 $R_{goff} = 16$ Ω

figure 38.

IGBT

Typical switching times as a function of gate resistor
 $t = f(R_g)$



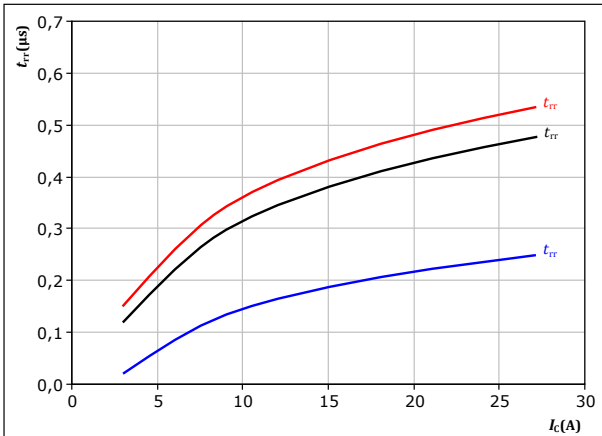
With an inductive load at

$T_j = 150$ °C
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 15$ A

figure 39.

FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$



With an inductive load at

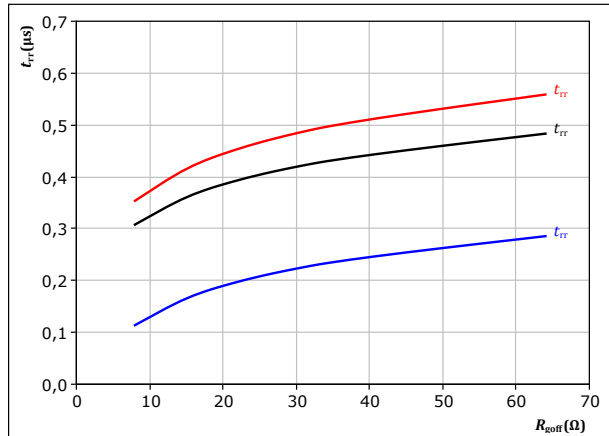
$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω

T_j : 25 °C (blue)
125 °C (black)
150 °C (red)

figure 40.

FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor
 $t_{rr} = f(R_{goff})$



With an inductive load at

$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 15$ A

T_j : 25 °C (blue)
125 °C (black)
150 °C (red)



Vincotech

10-FE12APA015SH01-PB18E08Z
datasheet

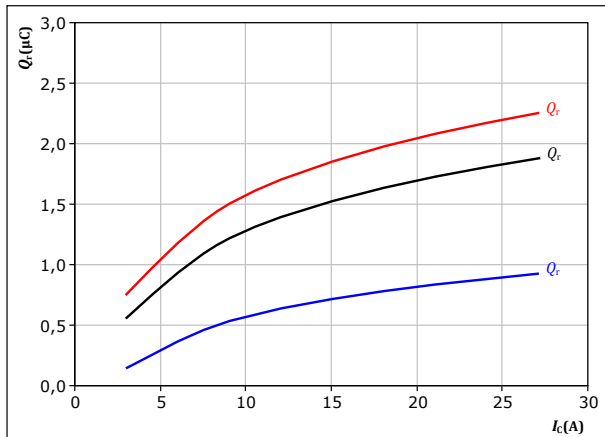
Inverter Switching Characteristics

figure 41.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω

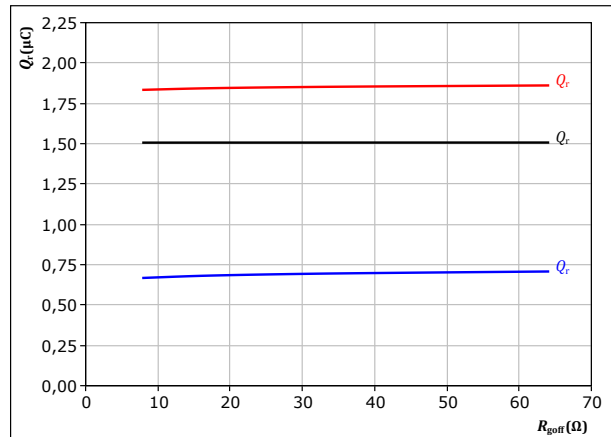
T_j : 25 °C
125 °C
150 °C

figure 42.

FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_c = 15$ A

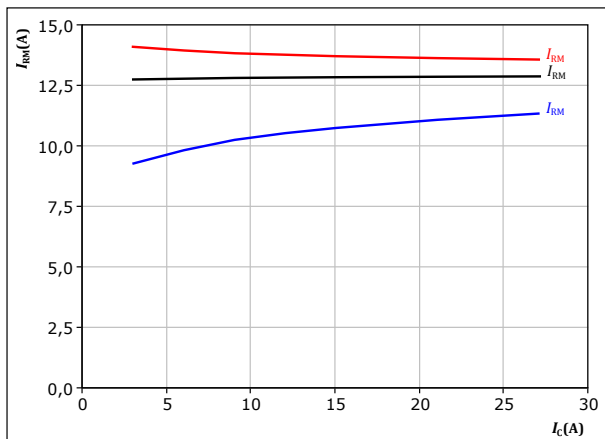
T_j : 25 °C
125 °C
150 °C

figure 43.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω

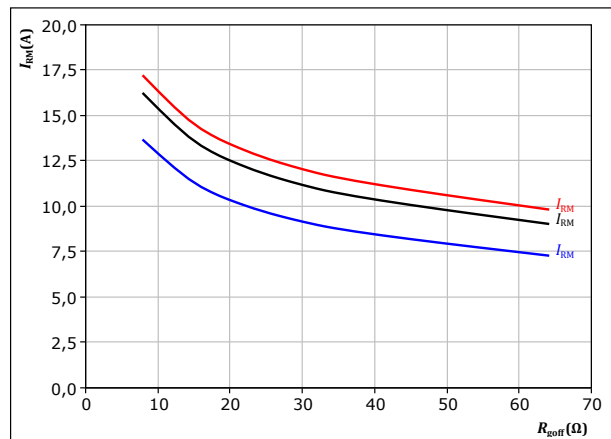
T_j : 25 °C
125 °C
150 °C

figure 44.

FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_c = 15$ A

T_j : 25 °C
125 °C
150 °C



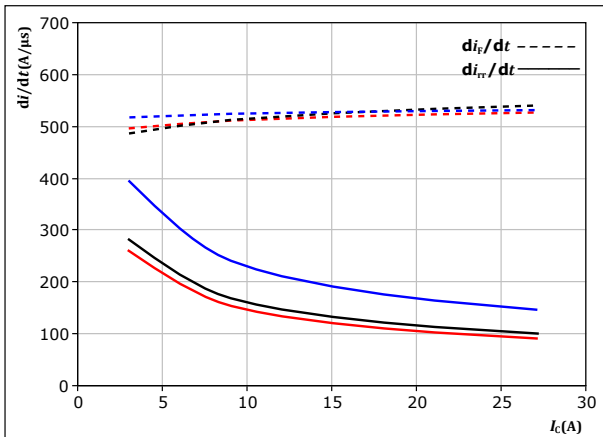
Vincotech

10-FE12APA015SH01-PB18E08Z
datasheet

Inverter Switching Characteristics

figure 45. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_r/dt = f(I_c)$

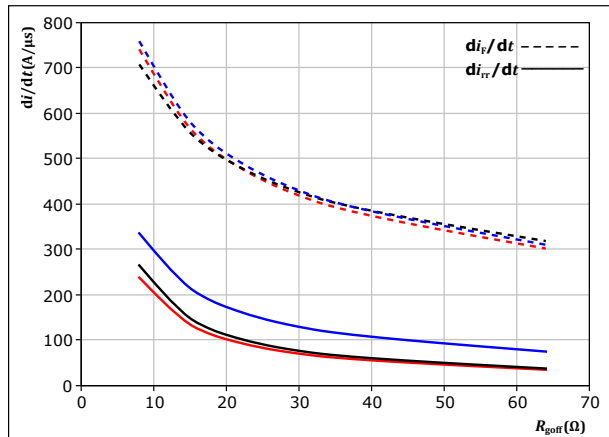


With an inductive load at

$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω
 $T_j = 25$ °C
 $T_j = 125$ °C
 $T_j = 150$ °C

figure 46. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_r/dt = f(R_{goff})$



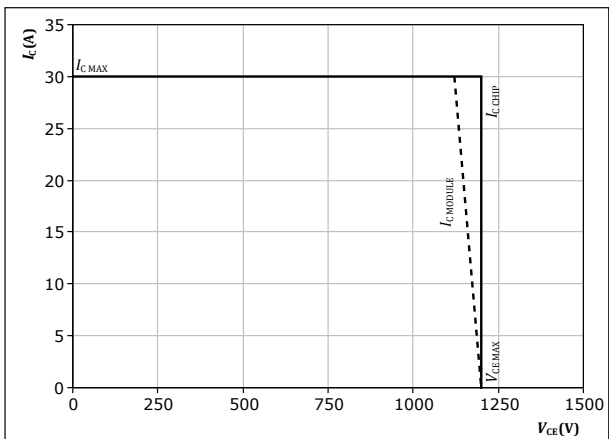
With an inductive load at

$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_c = 15$ A
 $T_j = 25$ °C
 $T_j = 125$ °C
 $T_j = 150$ °C

figure 47. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At $T_j = 150$ °C
 $R_{gon} = 16$ Ω
 $R_{goff} = 16$ Ω



Vincotech

10-FE12APA015SH01-PB18E08Z
datasheet

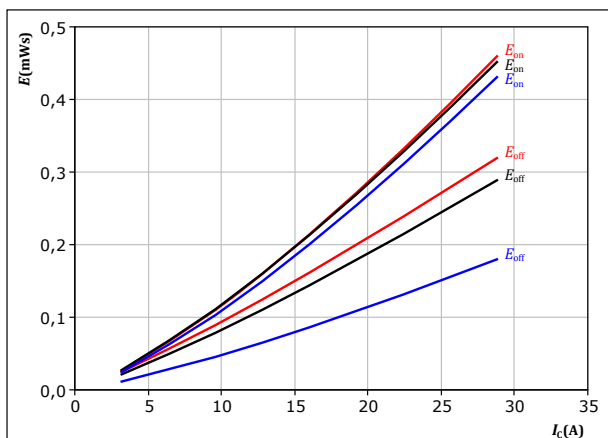
Negative Neutral Point Switching Characteristics

figure 48.

IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 16 \text{ } \Omega$
 $R_{goff} = 16 \text{ } \Omega$

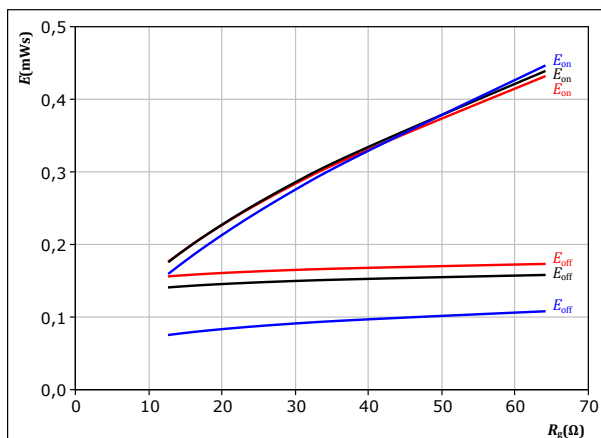
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 49.

IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 16 \text{ A}$

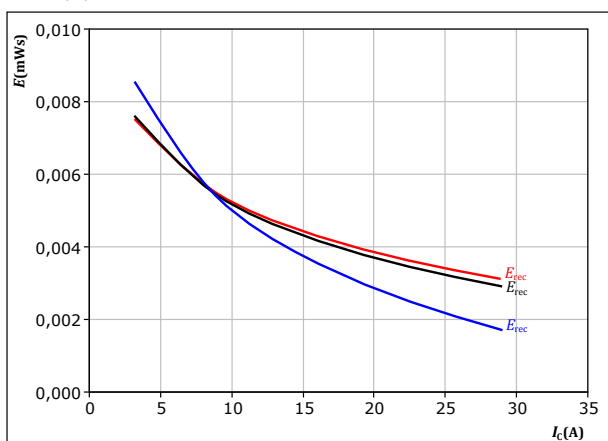
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 50.

FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 16 \text{ } \Omega$

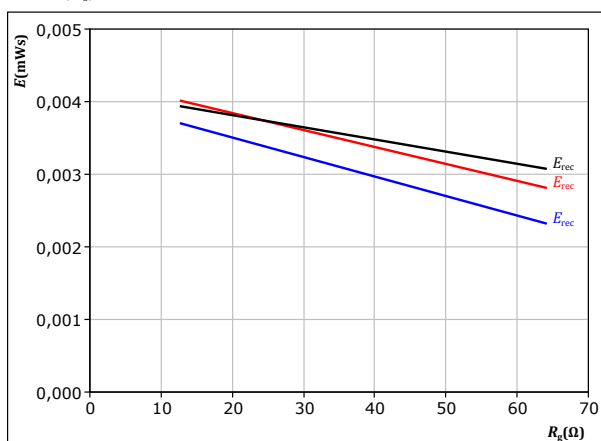
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 51.

FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 16 \text{ A}$

T_j :
— 25 °C
— 125 °C
— 150 °C



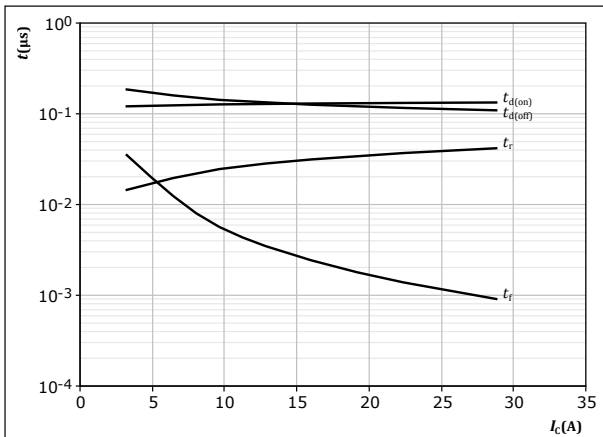
Vincotech

10-FE12APA015SH01-PB18E08Z
datasheet

Negative Neutral Point Switching Characteristics

figure 52. IGBT

Typical switching times as a function of collector current
 $t = f(I_c)$

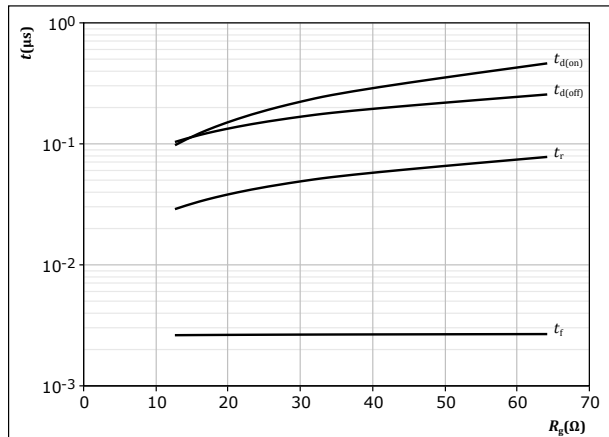


With an inductive load at

$T_j = 150$ °C
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω
 $R_{goff} = 16$ Ω

figure 53. IGBT

Typical switching times as a function of gate resistor
 $t = f(R_g)$

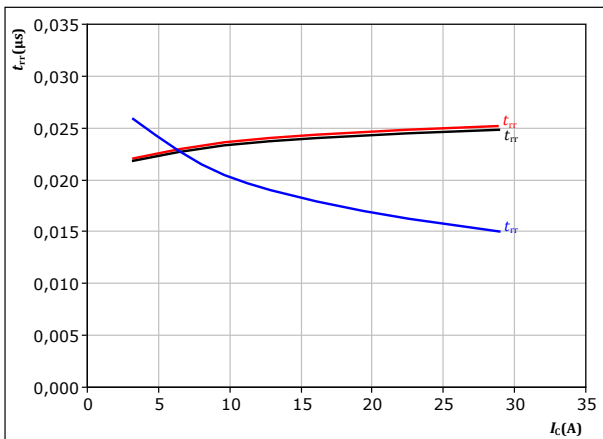


With an inductive load at

$T_j = 150$ °C
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 16$ A

figure 54. FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_c)$



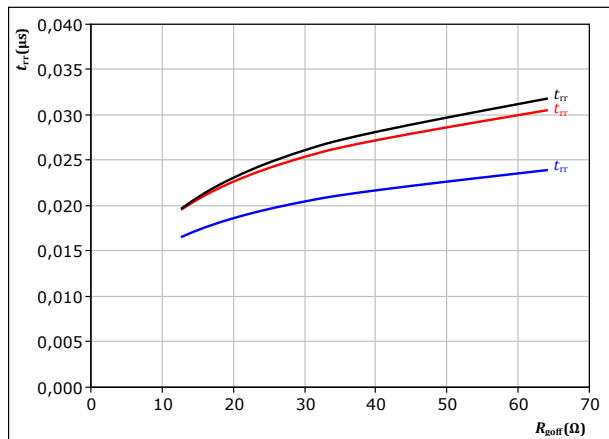
With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω

T_j : 25 °C
125 °C
150 °C

figure 55. FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor
 $t_{rr} = f(R_{goff})$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 16$ A

T_j : 25 °C
125 °C
150 °C



Vincotech

10-FE12APA015SH01-PB18E08Z
datasheet

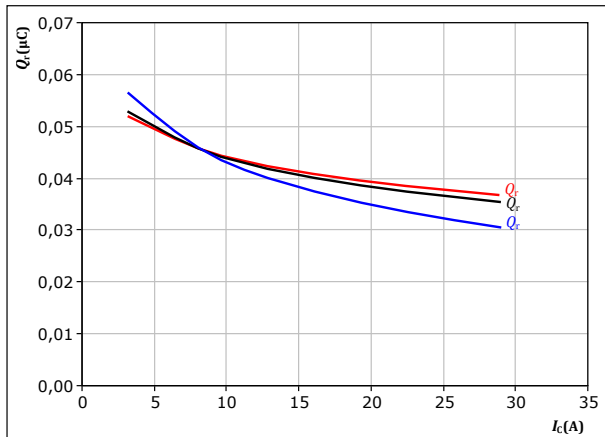
Negative Neutral Point Switching Characteristics

figure 56.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω

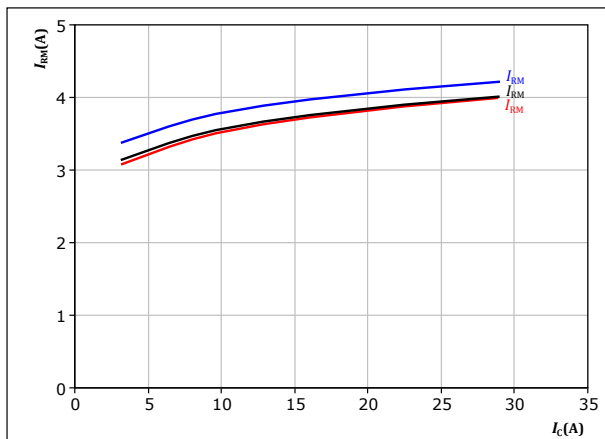
T_j : 25 °C
125 °C
150 °C

figure 58.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω

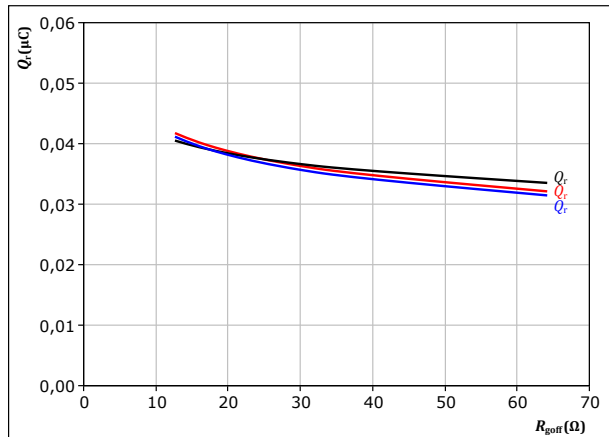
T_j : 25 °C
125 °C
150 °C

figure 57.

FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 16$ A

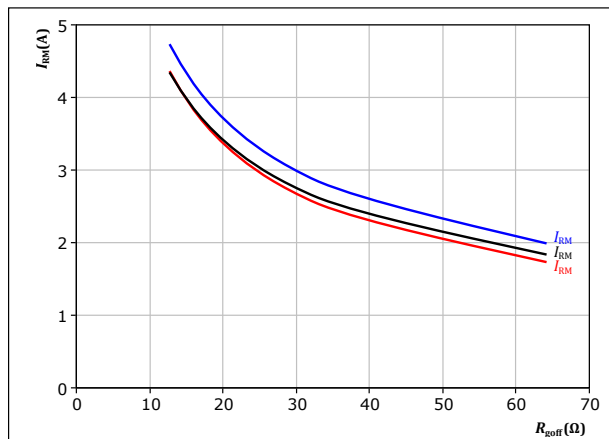
T_j : 25 °C
125 °C
150 °C

figure 59.

FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 16$ A

T_j : 25 °C
125 °C
150 °C



Vincotech

10-FE12APA015SH01-PB18E08Z
datasheet

Negative Neutral Point Switching Characteristics

figure 60. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_r/dt = f(I_C)$

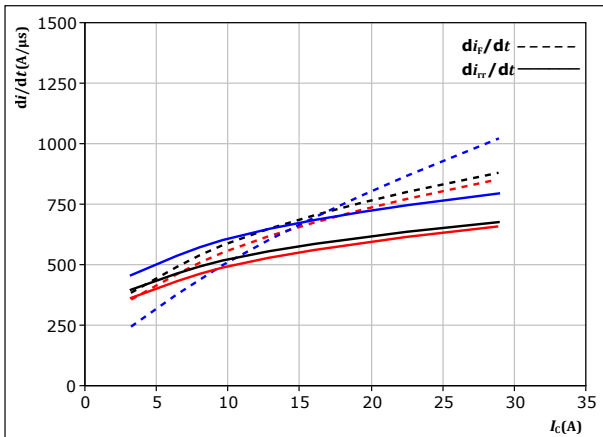


figure 61. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_r/dt = f(R_{goff})$

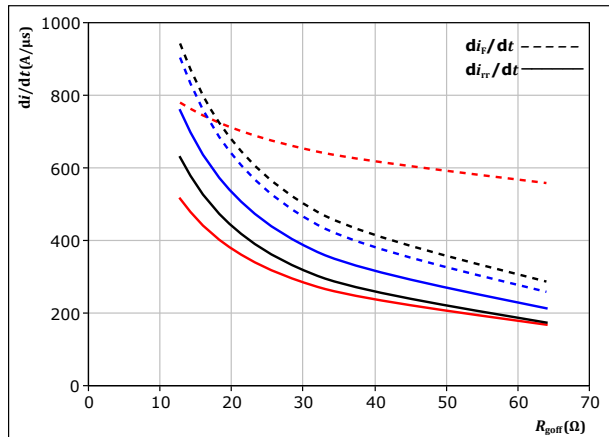
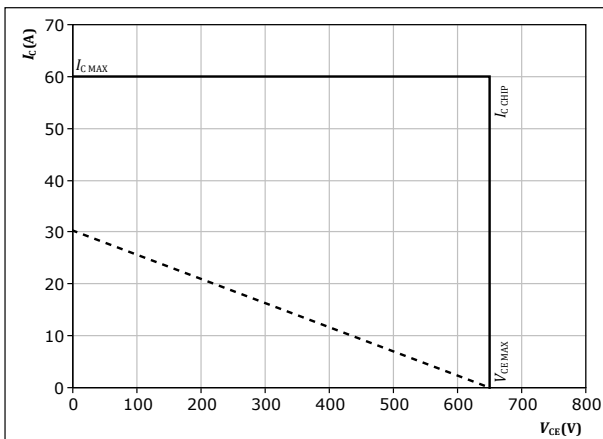


figure 62. IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$





Vincotech

10-FE12APA015SH01-PB18E08Z
datasheet

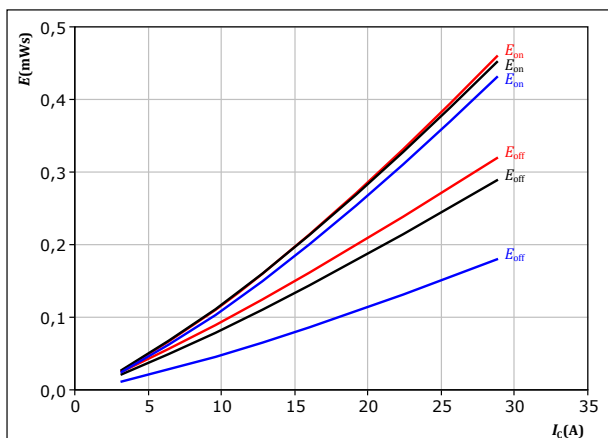
Positive Neutral Point Switching Characteristics

figure 63.

IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω
 $R_{goff} = 16$ Ω

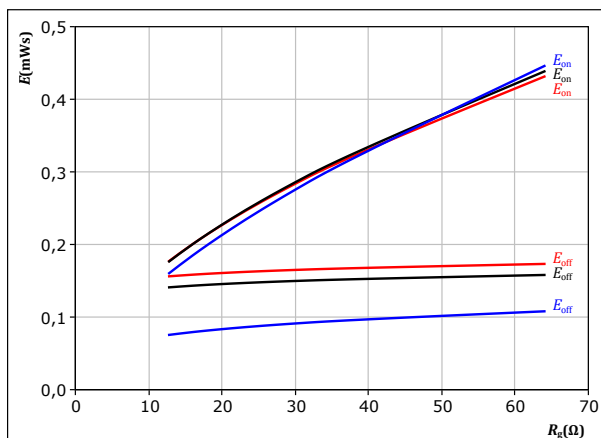
T_j : — 25 °C
— 125 °C
— 150 °C

figure 64.

IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 16$ A

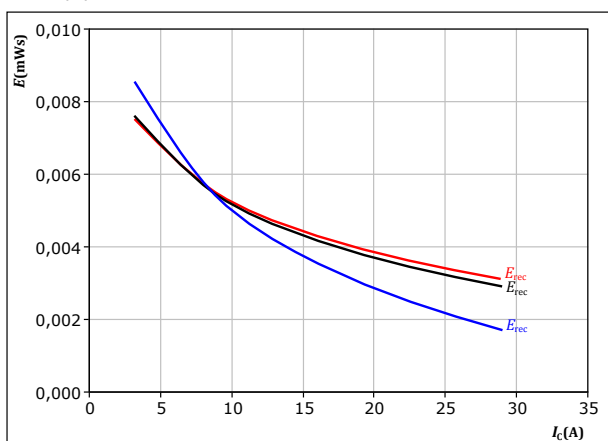
T_j : — 25 °C
— 125 °C
— 150 °C

figure 65.

FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω

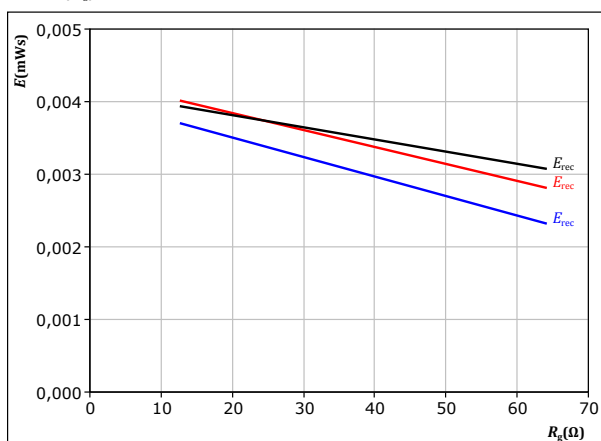
T_j : — 25 °C
— 125 °C
— 150 °C

figure 66.

FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 16$ A

T_j : — 25 °C
— 125 °C
— 150 °C



Vincotech

10-FE12APA015SH01-PB18E08Z
datasheet

Positive Neutral Point Switching Characteristics

figure 67.

IGBT

Typical switching times as a function of collector current

$$t = f(I_c)$$

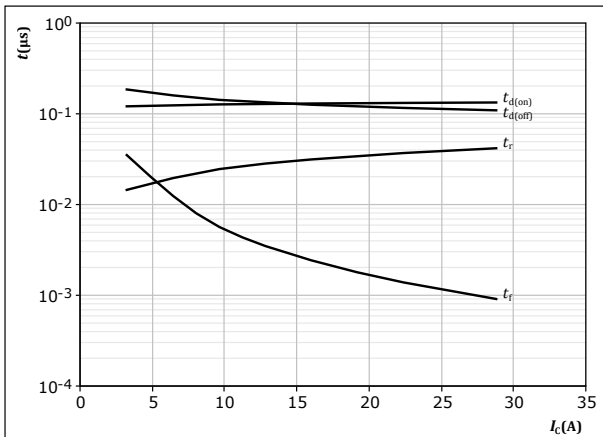


figure 68.

IGBT

Typical switching times as a function of gate resistor

$$t = f(R_g)$$

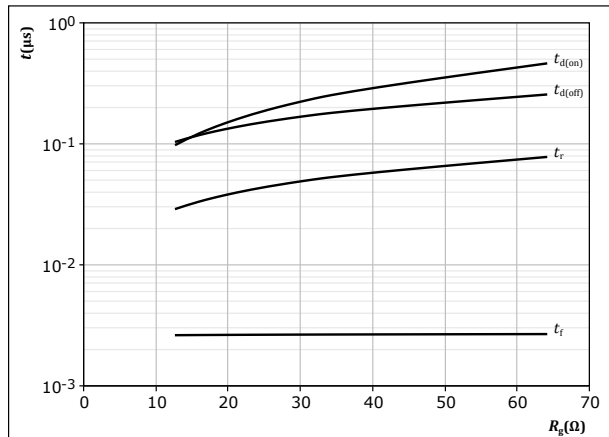


figure 69.

FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_c)$$

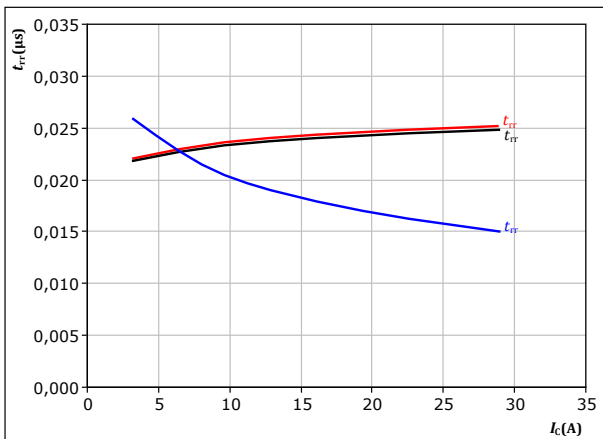
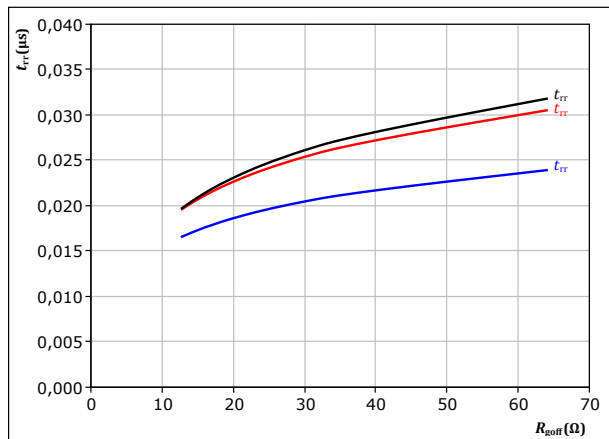


figure 70.

FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor

$$t_{rr} = f(R_{goff})$$





Vincotech

10-FE12APA015SH01-PB18E08Z
datasheet

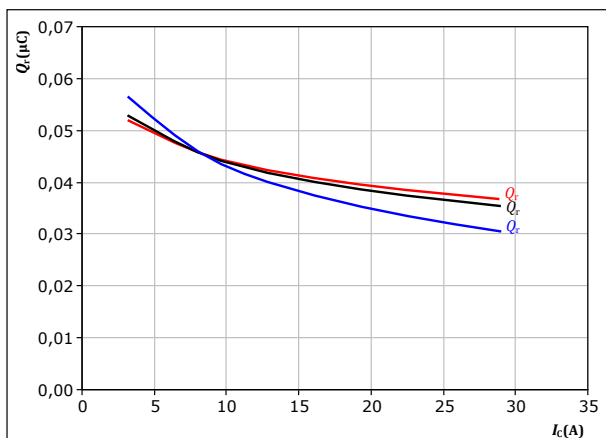
Positive Neutral Point Switching Characteristics

figure 71.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω

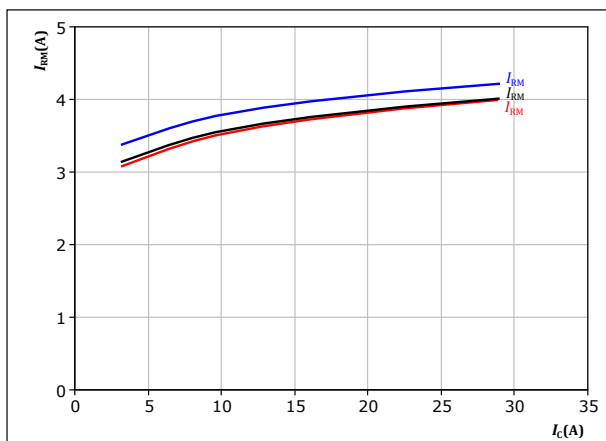
T_j : 25 °C
125 °C
150 °C

figure 73.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω

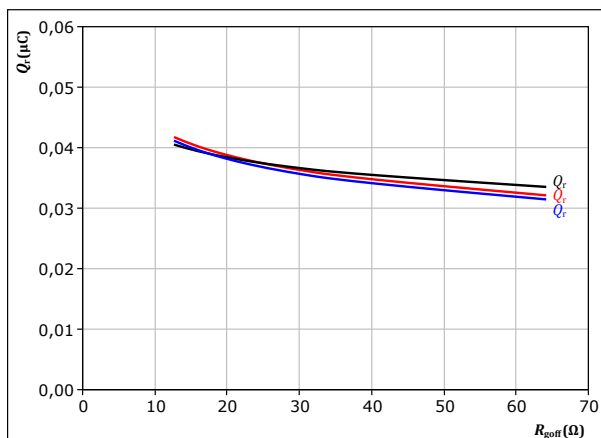
T_j : 25 °C
125 °C
150 °C

figure 72.

FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 16$ A

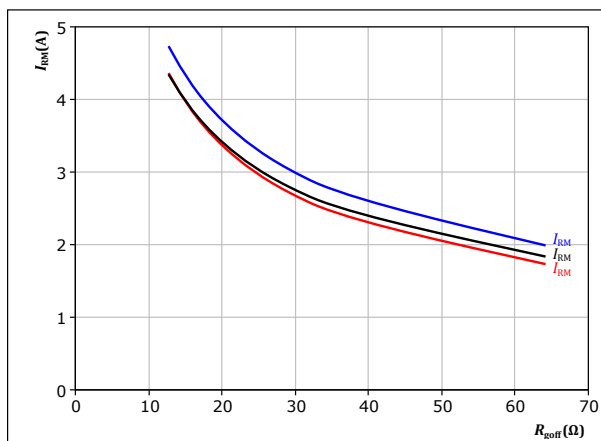
T_j : 25 °C
125 °C
150 °C

figure 74.

FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 16$ A

T_j : 25 °C
125 °C
150 °C



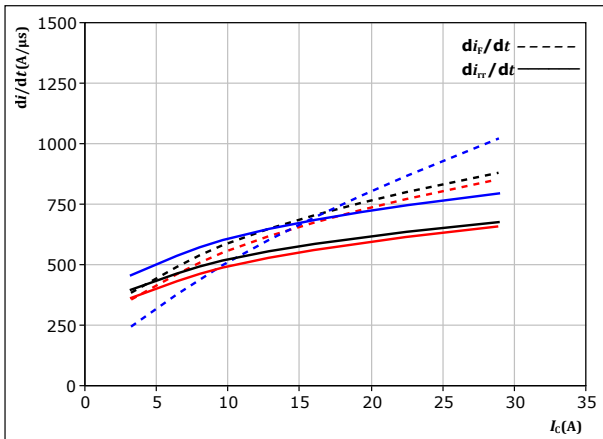
Vincotech

10-FE12APA015SH01-PB18E08Z
datasheet

Positive Neutral Point Switching Characteristics

figure 75. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_r/dt = f(I_C)$



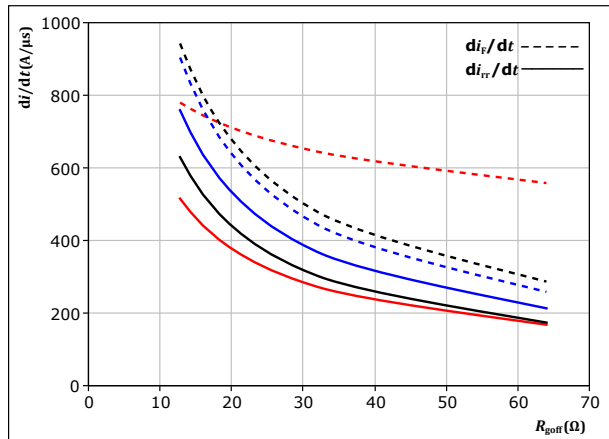
With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{goff} = 16$ Ω

T_j : 25 °C
125 °C
150 °C

figure 76. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_r/dt = f(R_{goff})$



With an inductive load at

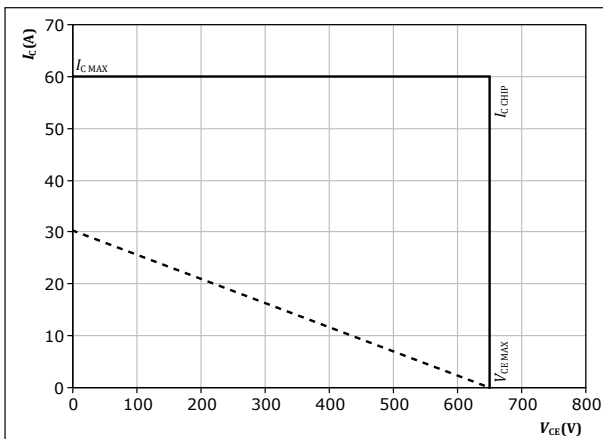
$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_C = 16$ A

T_j : 25 °C
125 °C
150 °C

figure 77. IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$



At $T_j = 150$ °C
 $R_{goff} = 16$ Ω
 $R_{goff} = 16$ Ω



Vincotech

Switching Definitions

figure 78.

IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

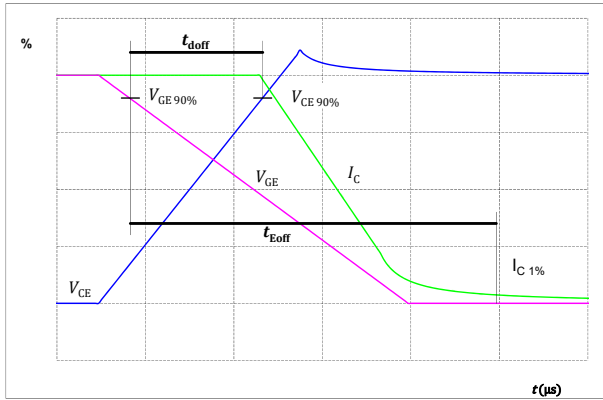


figure 79.

IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

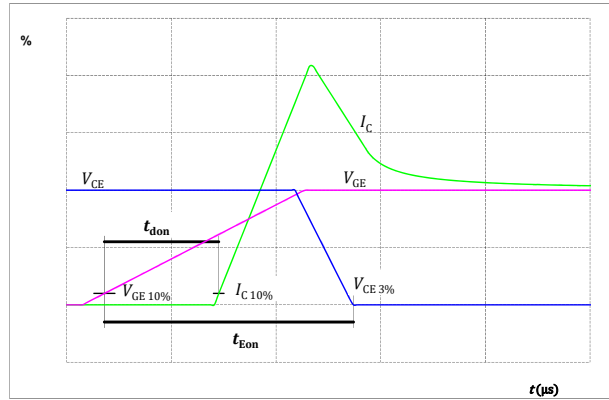


figure 80.

IGBT

Turn-off Switching Waveforms & definition of t_f

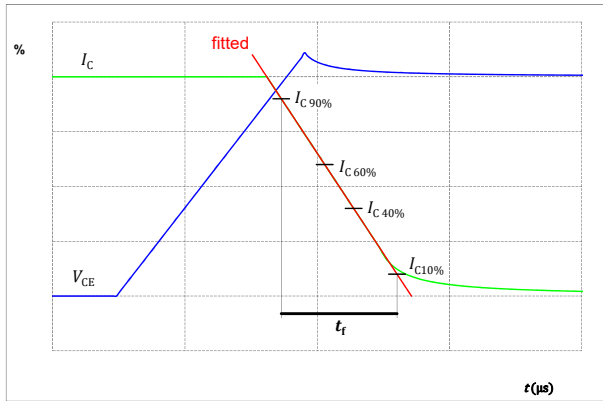
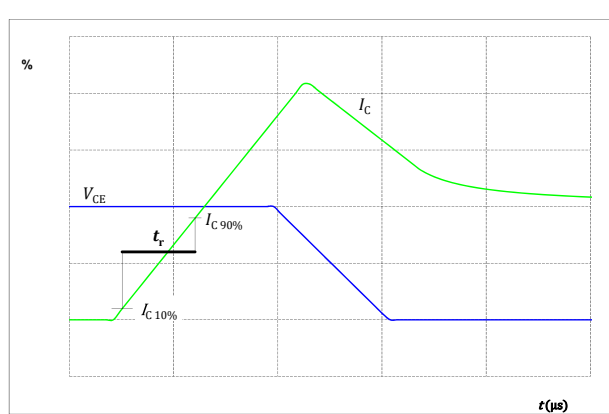


figure 81.

IGBT

Turn-on Switching Waveforms & definition of t_r





Vincotech

Switching Definitions

figure 82.

FWD

Turn-off Switching Waveforms & definition of t_{rr}

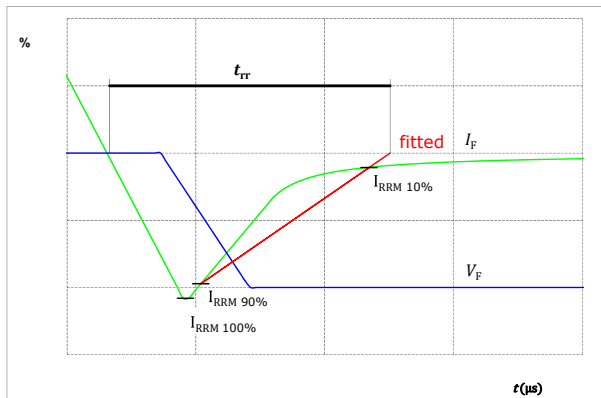
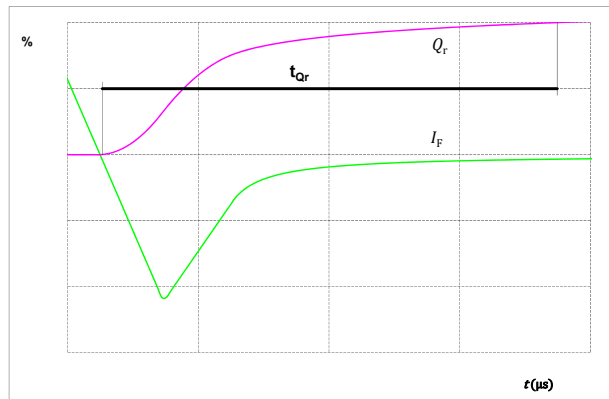


figure 83.

FWD


Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)





datasheet

Ordering Code	
Version	Ordering Code
Without thermal paste	10-FE12APA015SH01-PB18E08Z
With thermal paste (5,2 W/mK, PTM6000HV)	10-FE12APA015SH01-PB18E08Z-/7/
With thermal paste (3,4 W/mK, PSX-P7)	10-FE12APA015SH01-PB18E08Z-/3/

Marking							
	Text	Name		Date code	UL & VIN	Lot	Serial
		NN-NNNNNNNNNNNNN- TTTTTV		WWYY	UL VIN	LLLLL	SSSS
	Datamatrix	Type&Ver	Lot number	Serial	Date code		
		TTTTTTVV	LLLLL	SSSS	WWYY		

Outline

Pin table [mm]			
Pin	X	Y	Function
1	0	0	G15
2	3	0	DC-3
3	6	0	G13
4	9	0	DC-2
5	12	0	G11
6	15	0	DC-1
7	28,9	0	DC-PFC23
8	41,1	0	DC-PFC1
9	46,4	0	Therm2
10	52,8	0	Therm1
11	52,8	8,6	GND1
12	30,4	8,35	GND23
13	27,7	8,35	GND23
14	10,4	13,55	DC+Inv
15	17,9	13,55	S3
16	20,9	13,55	G3
17	26,35	16,7	DC+PFC23
18	29,05	16,7	DC+PFC23
19	37,15	13,65	G2
20	37,5	16,65	S2
21	46,2	13,95	G1
22	45,7	16,95	S1
23	52,8	16,7	DC+PFC1
24	52,8	23,3	TM51
25	34,95	24,05	TM61
26	26,35	24,05	TM71
27	0	25,8	G16
28	0	28,8	Ph3
29	5,7	25,8	G14
30	5,7	28,8	Ph2
31	11,4	25,8	G12
32	11,4	28,8	Ph1
33	23,35	28,8	ACin3
34	38,3	28,8	ACin2
35	52,8	28,8	ACin1

The technical drawing shows the physical layout of the power supply unit. The top view is a rectangle with a width of 264 mm and a height of 164 mm. It features four mounting holes at the corners and a central circular feature. Pin locations are marked with numbers 1 through 35. The side view shows the unit's profile with a height of 63 mm and a pin pitch of 0.64 mm. The pin table on the left lists the functions for each pin, including ground connections, DC inputs, AC inputs, and temperature sensors.

Tolerance of perpendicular: ± 0.5 mm of the end of pins.
Dimension of coordinate axis is only offset without tolerance

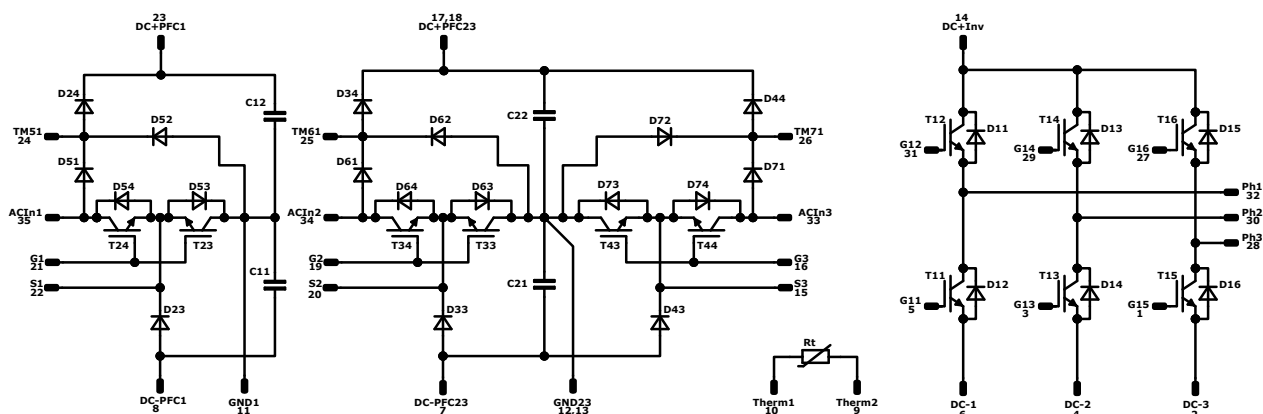


Vincotech

10-FE12APA015SH01-PB18E08Z

datasheet

Pinout




Identification

ID	Component	Voltage	Current	Function	Comment
T23, T33, T43	IGBT	650 V	30 A	Negative Neutral Point Switch	
T24, T34, T44	IGBT	650 V	30 A	Positive Neutral Point Switch	
D53, D63, D73	Rectifier	1600 V	18 A	Negative Neutral Point Diode	
D54, D64, D74	Rectifier	1600 V	18 A	Positive Neutral Point Diode	
T11, T12, T13, T14, T15, T16	IGBT	1200 V	15 A	Inverter Switch	
D11, D12, D13, D14, D15, D16	FWD	1200 V	15 A	Inverter Diode	
D24, D34, D44	FWD	650 V	16 A	Positive Boost Diode	
D51, D61, D71	Rectifier	1600 V	18 A	Positive Boost Blocking Diode	
D52, D62, D72	FWD	650 V	6 A	Positive Boost Diode Protection Diode	
D23, D33, D43	FWD	650 V	16 A	Negative Boost Diode	
C11, C12, C21, C22	Capacitor	630 V		Capacitor (PFC)	
Rt	Thermistor			Thermistor	



Vincotech

10-FE12APA015SH01-PB18E08Z
datasheet

Packaging instruction				
Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ	Sample
Handling instruction				
Handling instructions for <i>flow 1</i> packages see vincotech.com website.				
Package data				
Package data for <i>flow 1</i> packages see vincotech.com website.				
Vincotech thermistor reference				
See Vincotech thermistor reference table at vincotech.com website.				
UL recognition and file number				
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.				

Document No.:	Date:	Modification:	Pages
10-FE12APA015SH01-PB18E08Z-D1-14	4 Nov. 2021	Initial Release	

DISCLAIMER

The information, specifications, procedures, methods and recommendations herein (together "information") are presented by Vincotech to reader in good faith, are believed to be accurate and reliable, but may well be incomplete and/or not applicable to all conditions or situations that may exist or occur. Vincotech reserves the right to make any changes without further notice to any products to improve reliability, function or design. No representation, guarantee or warranty is made to reader as to the accuracy, reliability or completeness of said information or that the application or use of any of the same will avoid hazards, accidents, losses, damages or injury of any kind to persons or property or that the same will not infringe third parties rights or give desired results. It is reader's sole responsibility to test and determine the suitability of the information and the product for reader's intended use.

LIFE SUPPORT POLICY

Vincotech products are not authorised for use as critical components in life support devices or systems without the express written approval of Vincotech.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.